

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	35206	((imprint adj lithography) or print\$3) and (stamp\$3 or mold\$3 or template).clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 13:28
L4	654	((imprint adj lithography) or (\$5contact adj print\$3)) and (stamp\$3 or mold\$3 or template).clm. and \$5silicon	US-PGPUB; USPAT	OR	OFF	2006/09/24 13:29
L5	135	(216/44).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/24 14:01
L6	242	stamper.ti. and stamper.clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 14:23
L7	4	(silicon and protrusion\$1 and stamper).clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 14:24
L8	1	((stack adj structure) and protrusion\$1 and stamper).clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 14:24
S1	101	(stamp\$3 and lithography).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/09 12:13
S4	328	((imprint adj lithography) or (microcontact adj printing)) and (stamp\$3 or mold\$3).clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 13:27
S42	20	(US-20050202350-\$ or US-20020105103-\$ or US-20040081800-\$ or US-20030141276-\$ or US-20010027570-\$ or US-20040081798-\$ or US-20040038552-\$).did. or (US-5494782-\$ or US-6190838-\$ or US-6207247-\$ or US-6352656-\$ or US-5699848-\$ or US-5705246-\$ or US-5817242-\$ or US-5024744-\$ or US-6743368-\$ or US-4723903-\$ or US-6127100-\$ or US-6869557-\$ or US-6805809-\$).did.	US-PGPUB; USPAT	OR	OFF	2006/09/07 09:34
S43	10	S42 and silicon	US-PGPUB; USPAT	OR	OFF	2006/09/07 09:45
S44	7	((("6350360") or ("6306547") or ("6127263") or ("5789117") or ("5817242") or ("6190809") or ("20020050220"))).PN.	US-PGPUB; USPAT	OR	OFF	2006/09/07 09:46

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S45	156	(stamp\$2).ti. and silicon	US-PGPUB; USPAT	OR	OFF	2006/09/07 10:31
S46	33	(stamp\$2).ti. and silicon adj oxide	US-PGPUB; USPAT	OR	OFF	2006/09/07 10:32
S47	81	(stamp\$2).ti. and ((silicon adj oxide) or "SiO.sub.2")	US-PGPUB; USPAT	OR	OFF	2006/09/08 15:51
S48	7296	(stamp\$3 ant microcontact or imprint\$3) and ((silicon adj oxide) or "SiO.sub.2")	US-PGPUB; USPAT	OR	OFF	2006/09/08 15:52
S49	154	(stamp\$3 or microcontact or imprint\$3).ti. and ((silicon adj oxide) or "SiO.sub.2")	US-PGPUB; USPAT	OR	OFF	2006/09/08 16:07
S50	131	(template\$2 or mold or stamp\$3).ti. and (lithograph\$2 or microcontact or imprint\$3) and ((silicon adj oxide) or "SiO.sub.2")	US-PGPUB; USPAT	OR	OFF	2006/09/08 16:35
S51	44	(template\$2 or mold or stamp\$3).ti. and (lithograph\$2 or microcontact or imprint\$3) and (polysilicon)	US-PGPUB; USPAT	OR	OFF	2006/09/08 16:51
S52	5	(template\$2 or mold or stamp\$3).ti. and (lithograph\$2 or microcontact or imprint\$3) and (polycrystal\$4 near2 silicon)	US-PGPUB; USPAT	OR	OFF	2006/09/19 15:02
S53	52	(transparent with polysilicon with \$2oxide with nitride)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/09 12:16
S54	23	(opaque with polysilicon with (tungsten or tantalum))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/09 12:18
S55	36	(opaque with polysilicon with (tungsten or WSi or tantalum or silicide))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/09 12:19
S56	62	((hasegawa near2 mitsuru) (miyauchi near2 akihiro)).in.	US-PGPUB; USPAT	OR	OFF	2006/09/19 15:00
S57	4	(stamper and protrusion\$1 and silicon).clm.	US-PGPUB; USPAT	OR	OFF	2006/09/24 14:03